© Copy	rial Composition right 2005. IPC, Bar ional and Pan-Amer	nockburn, Illinois.	All rights reserved entions.	under both	This docume level parts, th	ent is a declar he declaration	ration of t n encomp	he substance basses all low	within the er level mat	manufactur erials for wl	er listed ite hich the m	em. Note anufactu	e: if the item is ar arer has engineeri	a assembly with loweng responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form T http://www.ipc.org/IPC-175x Distribution				e *	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier Information															
Company name*	Company u	Company unique ID			Unique ID Authority					Response Date*					
onsemi												2025-05-12			
Contact Name	Title - Con	Title - Contact			Phone - Contact*					Email - Contact*					
Product-Env-Stewards	Product En	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Authorized Representative*	Title - Rep	Title - Representative			Phone - Representative*				Email - Representative*						
Product-Env-Stewards	Product En	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com						
Requester Item Nur	Requester Item Number Mfr Item Number CM1214A-02MR					Effective Date Version Manufac		Manufactur	ing Site	Weight*		UOM	Unit Type		
						2025-05-12	-05-12 CNS			2	24.6 mg		Each		
Manufacturing Proccess	s Information		1			1							1	1	
Terminal Plating / G	nal Plating / Grid Array Material Termin		e Alloy	J-STD-020 MSL Rating		Peak Process Body Temper		dy Temperatu	ture Max Time at Peak Temp		Temperatu	ire Nu	mber of Reflow (Cycles	
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		no CU Alloy	U Alloy 1			260		C	30 seco		second	ls 3			
Comments															
evel 1 - maximum time at pea	ık temperature dur	ing soldering is 10	-30 seconds												
or more information regardi	ing material compo	sition please refer	to page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ess of the applicable quantity limit identified about the may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member we independently verified such information. How	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of							
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted								
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.												
Exemption List Version	EL-2011/534/EU											
Declaration Signature												
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.												
Supplier Digital Signature Ra	stislav Drska	Le										

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Clip	11.37	mg	Supplier	Zinc (Zn)	7440-66-6		0.0136	mg	
			Supplier	Iron (Fe)	7439-89-6		0.2729	mg	
			Supplier	Copper (Cu)	7440-50-8		11.0744	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0091	mg	
Die	1.39	mg	Supplier	Silicon (Si)	7440-21-3		1.39	mg	
Die Attach	0.19	mg	Supplier	Silver (Ag)	7440-22-4		0.1425	mg	
			Supplier	Epoxy resins	129915-35-1		0.0475	mg	
Mold Compound-Black	11.09	mg		Epoxy Phenol Resin	proprietary data		1.1644	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		9.9255	mg	
Plating	0.08	mg	Supplier	Palladium (Pd)	7440-05-3		0.0214	mg	
			В	Nickel (Ni)	7440-02-0		0.0556	mg	
			Supplier	Gold (Au)	7440-57-5		0.003	mg	
Wire Bond - Au	0.48	mg	Supplier	Gold (Au)	7440-57-5		0.48	mg	